

Title (en)

Method of adhering polishing pads and jig for adhering the same

Title (de)

Verfahren zum Anhaften von Polierkissen und Aufspannvorrichtung zum Anhaften derselben

Title (fr)

Méthode pour adhérer des disques de polissage et gabarit pour adhérer le même

Publication

**EP 1775068 B1 20090318 (EN)**

Application

**EP 06255244 A 20061012**

Priority

JP 2005301330 A 20051017

Abstract (en)

[origin: EP1775068A1] The method of adhering polishing pads (14a, 16a) is capable of easily exchanging polishing pads (14a, 16a) in a comfortable posture. The method comprises the steps of: setting a pad adhering carrier (49), which has a through-hole (49a) in which a roller unit (48) for pressing polishing pads (14a, 16a) is fixed, in a holder with arranging a roller unit (48) in a radial direction of a lower polishing plate (16) and an upper polishing plate (14); relatively moving the upper polishing plate (14) toward the lower polishing plate (16) so as to clamp the roller unit (48) between the lower polishing plate (16) and the upper polishing plate (14) with a prescribed force; rotating the lower polishing plate (16) and the upper polishing plate (14), which clamp the roller unit (48), in the opposite directions at the same speed; and pressing the polishing pads (14a, 16a) onto polishing faces of the lower polishing plate (16) and the upper polishing plate (14) by the roller unit (48).

IPC 8 full level

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CPC (source: EP KR US)

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Cited by

EP4212280A1; WO2020064282A1; WO2018086912A1; KR20190082271A; DE102017217490A1; DE102016222063A1; US11161217B2

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